IPC ASSOCIATION ELECTRONIC	Material Com © Copyright 2005. international and Pa	IPC. Bannockl	claration purn, Illinois. All rights reserved under both pyright conventions.			This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				*	* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Mater					als and Mi	g Information	on	
upplier	r Information														
Company name*				Company unique ID			Unique ID Authority					Response Date*			
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	Requester Item Number	Mfr Item	n Number	Mfr Item Name			Effective Date	Versio	n	Manufacturing Site		V	Veight*	UOM	Unit Type
		MUR460	0FFG	REC SURM 4A 60	00V ULTFST		2024-04-18			CNP		1	130.87	mg	Each
	cturing Process Information		Terminal Base	Alloy	STD-020 MS	I. Poting	Dank Proc	ass Rody	Tamparati	ura May Tir	na at Daak ^r	Tamparati	ura Numbe	er of Reflow Cyc	Jac
	8		CU Allov NA			L Katilig			y Temperature Max Time at Peak T		seconds 3		les		
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or more i	information regarding materia	l composition	nlease refer t	n nage 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale appl											
RoHS Declaration * 4 - Item(s	s) does not contain RoHS restricted substance	ces per the definition above except for selected exer	nptions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead). Exemption: 7c-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature R		,									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.67	mg	Supplier	Silicon (Si)	7440-21-3		2.6433	mg
			Supplier	Lead Bisilicate	65997-18-4	7c	0.0267	mg
Die Attach Solder	3.6		Supplier	Silver (Ag)	7440-22-4		0.09	mg
			A	Lead (Pb)	7439-92-1	7a	3.33	mg
			Supplier	Tin (Sn)	7440-31-5		0.18	mg
Lead Frame	738.3	mg	Supplier	Copper (Cu)	7440-50-8		738.3	mg
Mold Compound-Black	384.6			Metal Hydroxide	proprietary data		19.23	mg
			Supplier	Carbon Black (C)	1333-86-4		3.846	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		288.45	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		38.46	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		34.614	mg
Plating	1.7	mg	Supplier	Tin (Sn)	7440-31-5		1.7	mg